

Description

The 5PB11xx is a high-performance LVCMOS clock buffer family. It has best-in-class additive phase jitter of 50fsec RMS.

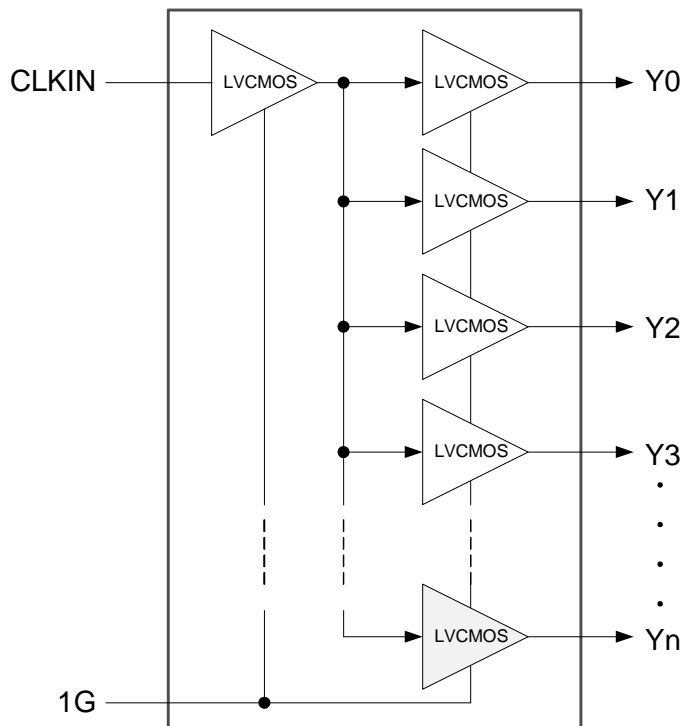
There are five different fan-out variations available: 1:2 to 1:10.

The 5PB11xx also supports a synchronous glitch-free output enable (OE) function to eliminate any potential intermediate incorrect output clock cycles when enabling or disabling outputs. It's available in various packages and can operate from a 1.8V to 3.3V supply.

Features

- High-performance 1:2, 1:4, 1:6, 1:8, 1:10 LVCMOS clock buffer
- Very low pin-to-pin skew < 50ps
- Very low additive jitter < 50fs
- Supply voltage: 1.8V to 3.3V
- 3.3V tolerant input clock
- $f_{MAX} = 200\text{MHz}$
- Integrated serial termination for 50Ω channel
- Packaged in 8-, 14-, 16-, 20-pin TSSOP and as small as 2×2 mm DFN and QFN packages
- Industrial (-40°C to $+85^{\circ}\text{C}$) and extended (-40°C to $+105^{\circ}\text{C}$) temperature ranges

Block Diagram



Pin Assignments for TSSOP Packages

CLKIN	1	8	Y1
1G	2	7	NC
Y0	3	6	VDD
GND	4	5	NC

5PB1102PGG

CLKIN	1	8	Y1
1G	2	7	Y3
Y0	3	6	VDD
GND	4	5	Y2

5PB1104PGG

CLKIN	1	14	Y1
1G	2	13	Y3
Y0	3	12	VDD
GND	4	11	Y2
VDD	5	10	GND
Y4	6	9	Y5
GND	7	8	VDD

5PB1106PGG

CLKIN	1	16	Y1
1G	2	15	Y3
Y0	3	14	VDD
GND	4	13	Y2
VDD	5	12	GND
Y4	6	11	Y5
GND	7	10	VDD
Y6	8	9	Y7

5PB1108PGG

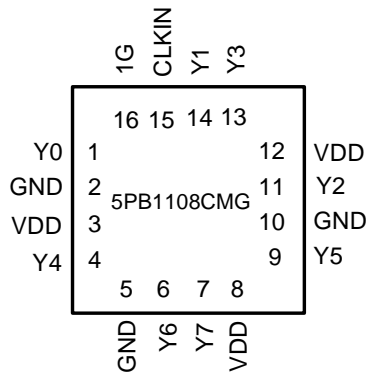
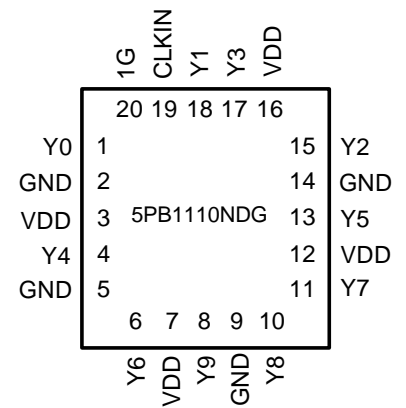
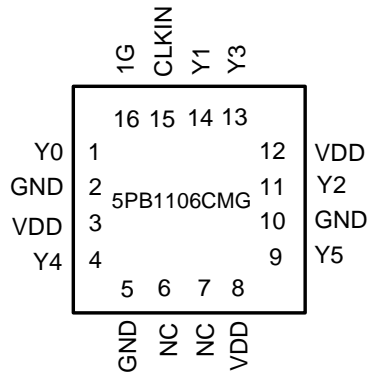
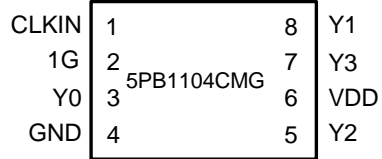
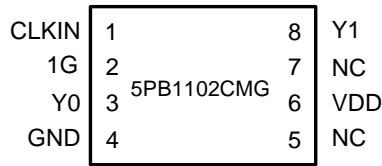
CLKIN	1	20	Y1
1G	2	19	Y3
Y0	3	18	VDD
GND	4	17	Y2
VDD	5	16	GND
Y4	6	15	Y5
GND	7	14	VDD
Y6	8	13	Y7
VDD	9	12	Y8
Y9	10	11	GND

5PB1110PGG

Pin Descriptions for TSSOP Packages

Device Number	LVC MOS Clock Input	Clock Output Enable	LVC MOS Clock Output	Supply Voltage	Ground
	CLKIN	1G	Y0, Y1, . . . Y9	VDD	GND
5PB1102PGG	1	2	3, 8	6	4
5PB1104PGG	1	2	3, 8, 5, 7	6	4
5PB1106PGG	1	2	3, 14, 11, 13, 6, 9	5, 8, 12	4, 7, 10
5PB1108PGG	1	2	3, 16, 13, 15, 6, 11, 8, 9	5, 10, 14	4, 7, 12
5PB1110PGG	1	2	3, 20, 17, 19, 6, 15, 8, 13, 12, 10	5, 9, 14, 18	4, 7, 11, 16

Pin Assignments for DFN/QFN Packages



Pin Descriptions for DFN/QFN Packages

Device Number	LVC MOS Clock Input	Clock Output Enable	LVC MOS Clock Output	Supply Voltage	Ground
	CLKIN	1G	Y0, Y1, . . . Y9	VDD	GND
5PB1102CMG	1	2	3, 8	6	4
5PB1104CMG	1	2	3, 5, 7, 8	6	4
5PB1106CMG	15	16	1, 4, 9, 11, 13, 14	3, 8, 12	2, 5, 10
5PB1108CMG	15	16	1, 4, 6, 7, 9, 11, 13, 14	3, 8, 12	2, 5, 10
5PB1110NDG	19	20	1, 4, 6, 8, 10, 11, 13, 15, 17, 18	3, 7, 12, 16	2, 5, 9, 14

Output Logic Table

Inputs		Output
CLKIN	1G	Yn
X	L	L
L	H	L
H	H	H

After at least three cycles of input clock toggling, Output Enable function is asynchronous to eliminate any intermediate incorrect output clock cycles during transition which may cause frequency peaking to the downstream device.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 5PB11xx. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, V_{DD}	3.8V
Output Enable and All Outputs	-0.4 V to $V_{DD} + 0.5$ V
CLKIN	-0.4 V to 3.465V
Ambient Operating Temperature (industrial)	-40 to +85°C
Ambient Operating Temperature (extended)	-40 to +105°C
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C

Recommended Operation Conditions

Parameter	Min.	Typ.	Max.	Units
Ambient Operating Temperature (industrial)	-40		+85	°C
Ambient Operating Temperature (extended)	-40		+105	°C
Power Supply Voltage (measured in respect to GND)	+1.71		+3.465	V

DC Electrical Characteristics

($V_{DD} = 1.8V, 2.5V, 3.3V$)

$V_{DD} = 1.8V \pm 5\%$, Ambient temperature -40° to +105°C, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	V_{DD}		1.71		1.89	V
Input High Voltage, CLKIN	V_{IH}	Note 1.	$0.7 \times V_{DD}$		3.465	V
Input Low Voltage, CLKIN	V_{IL}	Note 1.			$0.3 \times V_{DD}$	V
Input High Voltage, 1G	V_{IH}		1.6		V_{DD}	V
Input Low Voltage, 1G	V_{IL}				0.6	V
Output High Voltage	V_{OH}	$I_{OH} = -5mA$.	1.4			V
Output Low Voltage	V_{OL}	$I_{OL} = 5mA$.			0.4	V
Nominal Output Impedance	Z_O			50		Ω
Input Capacitance	C_{IN}	CLKIN, 1G pin.		5		pF
Operating Supply Current						
5PB1102	I_{DD}	100MHz, no load, 25°C.		6	8	mA
5PB1104		100MHz, no load, 25°C.		12	13	
5PB1106		100MHz, no load, 25°C.		15	18	
5PB1108		100MHz, no load, 25°C.		20	23	
5PB1110		100MHz, no load, 25°C.		23	27	

Notes: 1. Nominal switching threshold is $V_{DD}/2$.

$V_{DD} = 2.5V \pm 5\%$, Ambient temperature -40° to $+105^{\circ}C$, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	V_{DD}		2.375		2.625	V
Input High Voltage, CLKIN	V_{IH}	Note 1.	$0.7 \times V_{DD}$		3.465	V
Input Low Voltage, CLKIN	V_{IL}	Note 1.			$0.3 \times V_{DD}$	V
Input High Voltage, 1G	V_{IH}		1.8		V_{DD}	V
Input Low Voltage, 1G	V_{IL}				0.7	V
Output High Voltage	V_{OH}	$I_{OH} = -8mA$.	1.9			V
Output Low Voltage	V_{OL}	$I_{OL} = 8mA$.			0.5	V
Nominal Output Impedance	Z_O			50		Ω
Input Capacitance	C_{IN}	CLKIN, 1G pin.		5		pF
Operating Supply Current						
5PB1102	I_{DD}	100MHz, no load, $25^{\circ}C$.		9	11	mA
5PB1104		100MHz, no load, $25^{\circ}C$.		15	18	
5PB1106		100MHz, no load, $25^{\circ}C$.		21	24	
5PB1108		100MHz, no load, $25^{\circ}C$.		27	31	
5PB1110		100MHz, no load, $25^{\circ}C$.		32	37	

$V_{DD} = 3.3V \pm 5\%$, Ambient temperature -40° to $+105^{\circ}C$, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Operating Voltage	V_{DD}		3.135		3.465	V
Input High Voltage, CLKIN	V_{IH}	Note 1.	$0.7 \times V_{DD}$		3.465	V
Input Low Voltage, CLKIN	V_{IL}	Note 1.			$0.3 \times V_{DD}$	V
Input High Voltage, 1G	V_{IH}		2		V_{DD}	V
Input Low Voltage, 1G	V_{IL}				0.8	V
Output High Voltage	V_{OH}	$I_{OH} = -12mA$.	2.4			V
Output Low Voltage	V_{OL}	$I_{OL} = 12mA$.			0.7	V
Nominal Output Impedance	Z_O			50		Ω
Input Capacitance	C_{IN}	CLKIN, 1G pin.		5		pF
Operating Supply Current						
5PB1102	I_{DD}	100MHz, no load, $25^{\circ}C$.		12	13	mA
5PB1104		100MHz, no load, $25^{\circ}C$.		20	22	
5PB1106		100MHz, no load, $25^{\circ}C$.		25	30	
5PB1108		100MHz, no load, $25^{\circ}C$.		35	38	
5PB1110		100MHz, no load, $25^{\circ}C$.		40	45	

AC Electrical Characteristics

($V_{DD} = 1.8V, 2.5V, 3.3V$)

$V_{DD} = 1.8V \pm 5\%$, Ambient Temperature -40° to $+105^\circ C$, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time (2pF load)	t_{OR}	0.36V to 1.44V, $C_L = 2pF$.		0.5	0.75	ns
Output Fall Time (2pF load)	t_{OF}	1.44V to 0.36V, $C_L = 2pF$.		0.5	0.75	ns
Output Rise Time (5pF load)	t_{OR}	0.36V to 1.44V, $C_L = 5pF$.		0.8	1.0	ns
Output Fall Time (5pF load)	t_{OF}	1.44V to 0.36V, $C_L = 5pF$.		0.8	1.0	ns
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after V_{DD} ramp-up.			3	ms
Propagation Delay		Note 1.	1.5	1.9	2.5	ns
Buffer Additive Phase Jitter, RMS		156.25MHz, Integration Range: 12kHz–20MHz.			0.05	ps
Output to Output Skew (5PB1102/04)		Rising edges at $V_{DD}/2$, Note 2.		35	50	ps
Output to Output Skew (5PB1106)		Rising edges at $V_{DD}/2$, Note 2.		35	58	ps
Output to Output Skew (5PB1108/10)		Rising edges at $V_{DD}/2$, Note 2.		45	65	ps
Device to Device Skew		Rising edges at $V_{DD}/2$.			200	ps
Output Enable Time	t_{EN}	$C_L \leq 5pF$.			3	cycles
Output Disable Time	t_{DIS}	$C_L \leq 5pF$.			3	cycles
Duty Cycle	t_{DC}	See note 3.		50		%

$V_{DD} = 2.5V \pm 5\%$, Ambient Temperature -40° to $+105^\circ C$, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time (2pF load)	t_{OR}	0.5V to 2.0V, $C_L = 2pF$.		0.4	0.7	ns
Output Fall Time (2pF load)	t_{OF}	2.0V to 0.5V, $C_L = 2pF$.		0.4	0.7	ns
Output Rise Time (5pF load)	t_{OR}	0.5V to 2.0V, $C_L = 5pF$.		0.75	1.0	ns
Output Fall Time (5pF load)	t_{OF}	2.0V to 0.5V, $C_L = 5pF$.		0.75	1.0	ns
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after V_{DD} ramp-up.			3	ms
Propagation Delay (5PB1102/04)		Note 1.	1.9	2.4	2.9	ns
Propagation Delay (5PB1106/08)			2.0	2.4	3.3	ns
Propagation Delay (5PB1110)			2.0	2.4	3.0	ns
Buffer Additive Phase Jitter, RMS		156.25MHz, Integration Range: 12kHz–20MHz.			0.05	ps
Output to Output Skew (5PB1102/04)		Rising edges at $V_{DD}/2$, Note 2.		35	50	ps
Output to Output Skew (5PB1106)		Rising edges at $V_{DD}/2$, Note 2.		35	58	ps
Output to Output Skew (5PB1108/10)		Rising edges at $V_{DD}/2$, Note 2.		45	65	ps
Device to Device Skew		Rising edges at $V_{DD}/2$.			200	ps
Output Enable Time	t_{EN}	$C_L \leq 5pF$.			3	cycles
Output Disable Time	t_{DIS}	$C_L \leq 5pF$.			3	cycles
Duty Cycle	t_{DC}	See note 3.		50		%

$V_{DD} = 3.3V \pm 5\%$, Ambient Temperature -40° to $+105^\circ C$, unless stated otherwise.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency			0		200	MHz
Output Rise Time (2pF load)	t_{OR}	0.66V to 2.64V, $C_L = 2pF$.		0.45	0.6	ns
Output Fall Time (2pF load)	t_{OF}	2.64V to 0.66V, $C_L = 2pF$.		0.45	0.6	ns

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Output Rise Time (5pF load)	t_{OR}	0.66V to 2.64V, $C_L = 5pF$.		0.7	1.0	ns
Output Fall Time (5pF load)	t_{OF}	2.64V to 0.66V, $C_L = 5pF$.		0.7	1.0	ns
Start-up Time	$t_{START-UP}$	Part start-up time for valid outputs after V_{DD} ramp-up.			3	ms
Propagation Delay (5PB1102/04)		Note 1.	1.7	2	2.4	ns
Propagation Delay (5PB1106/08)			1.7	2	2.7	ns
Propagation Delay (5PB1110)			1.7	2	2.5	ns
Buffer Additive Phase Jitter, RMS		156.25MHz, Integration Range: 12kHz–20MHz.			0.05	ps
Output to Output Skew (5PB1102/04)		Rising edges at $V_{DD}/2$, Note 2.		35	50	ps
Output to Output Skew (5PB1106)		Rising edges at $V_{DD}/2$, Note 2.		35	58	ps
Output to Output Skew (5PB1108/10)		Rising edges at $V_{DD}/2$, Note 2.		45	65	ps
Device to Device Skew		Rising edges at $V_{DD}/2$.			200	ps
Output Enable Time	t_{EN}	$C_L \leq 5pF$.			3	cycles
Output Disable Time	t_{DIS}	$C_L \leq 5pF$.			3	cycles
Duty Cycle	t_{DC}	See note 3.		50		%

Notes:

1. With rail to rail input clock.
2. Between any 2 outputs with equal loading.
3. Duty cycle on outputs will match incoming clock duty cycle when V_{IH} on CLKIN pin equals V_{DD} power supply voltage. Consult IDT for tight duty cycle clock generators.

Phase Noise Plots

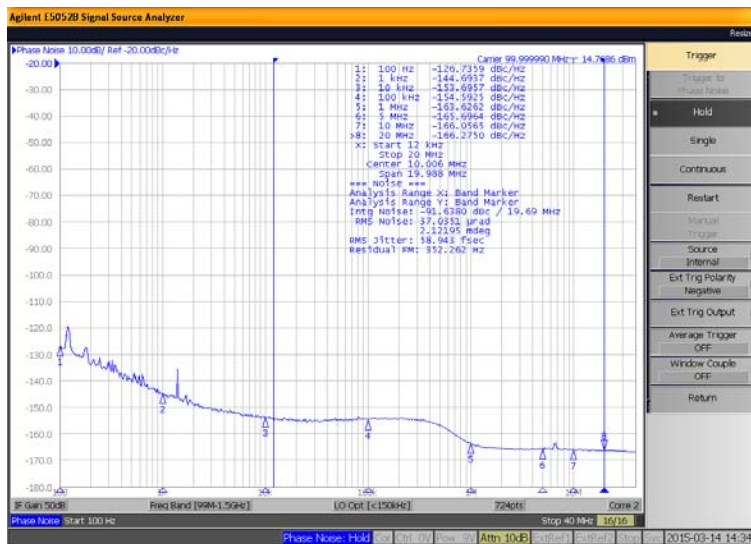


Figure 1. 5PB11xx Reference Phase Noise 58.9fs (12kHz to 20MHz)

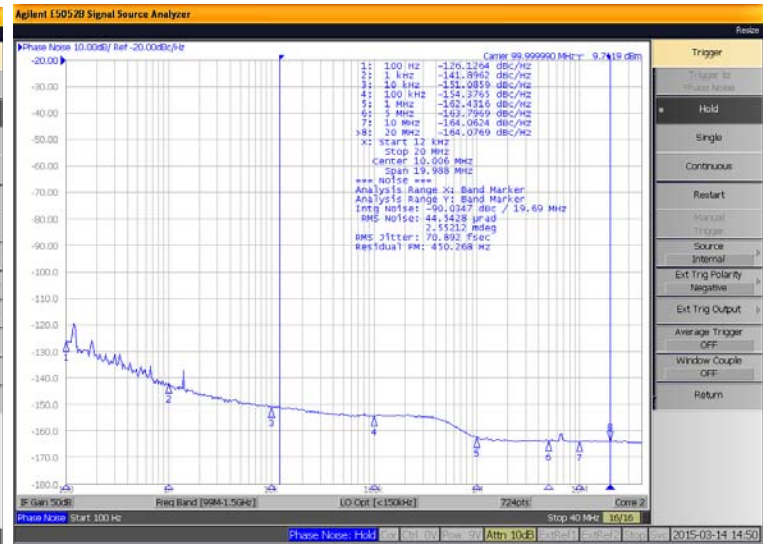
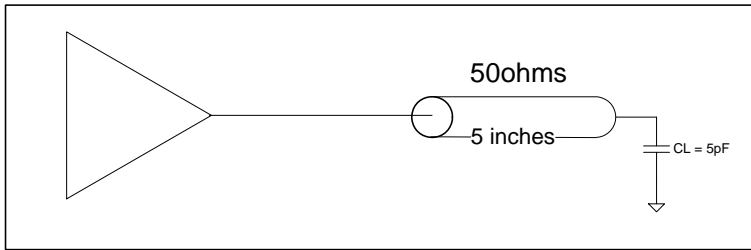


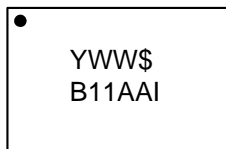
Figure 2. 5PB11xx Output Phase Noise 70.9fs (12kHz to 20MHz)

The phase noise plots above show the low additive jitter of the 5PB11xx high-performance buffer. With an integration range of 12kHz to 20MHz, the reference input has about 58.9fs of RMS phase jitter while the output of 5PB11xx has about 70.9fs of RMS phase jitter. This results in a low additive phase jitter of only 39fs.

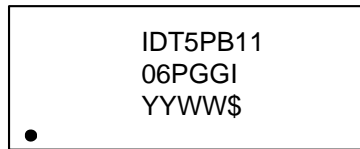
Test Load and Circuit



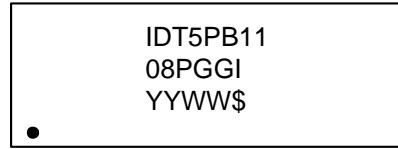
Marking Diagrams (industrial temperature range)



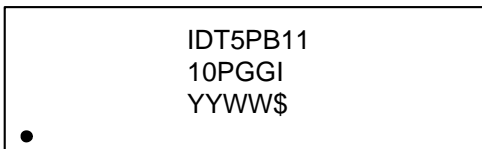
8-pin TSSOP



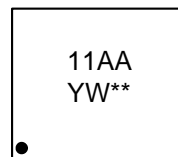
14-pin TSSOP



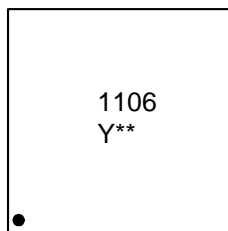
16-pin TSSOP



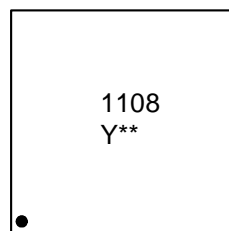
20-pin TSSOP



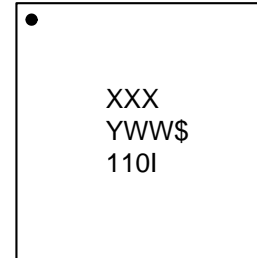
8-pin DFN



16-pin QFN



16-pin QFN

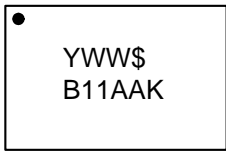


20-pin QFN

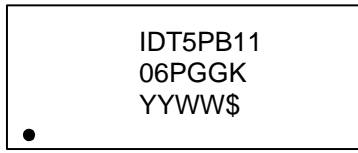
Notes:

1. "AA" denotes the last two digits of the part number for 8-TSSOP and DFN (e.g. 02, 04).
2. "**" is the lot sequence.
3. "XXX" denotes the last three characters of the Asm lot (20-QFN only).
4. "YYWW", "YWW", "YW", or "Y" is the last digit(s) of the year and week that the part was assembled.
5. "\$" denotes the mark code.
6. "G" after the two-letter package code denotes RoHS compliant package.
7. "I" denotes industrial temperature range device.
8. Bottom marking: LOT and COO (TSSOP only).

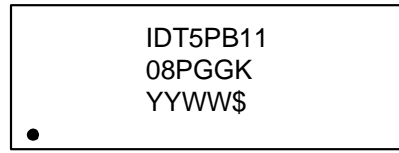
Marking Diagrams (extended temperature range)



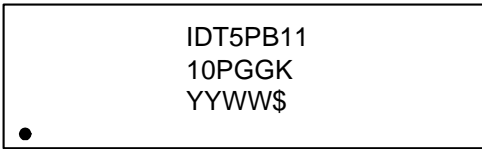
8-pin TSSOP



14-pin TSSOP



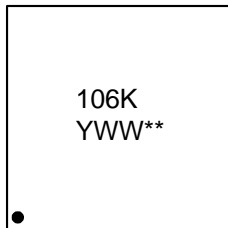
16-pin TSSOP



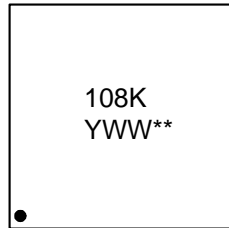
20-pin TSSOP



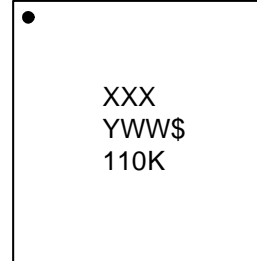
8-pin DFN



16-pin QFN



16-pin QFN



20-pin QFN

Notes:

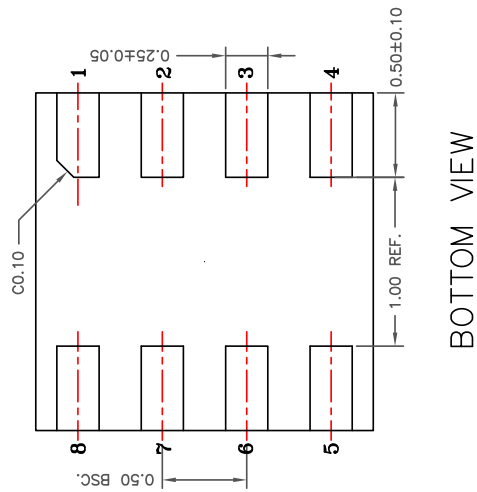
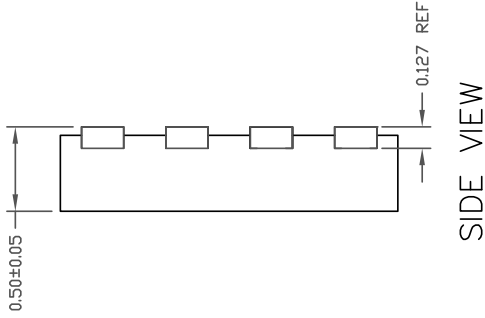
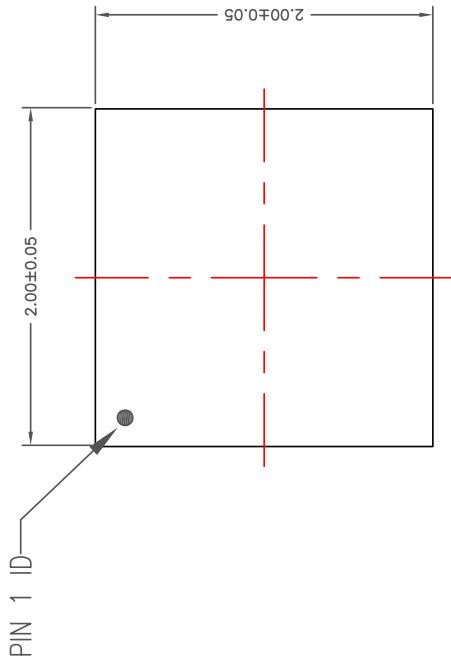
1. "AA" denotes the last two digits of the part number for 8-TSSOP and DFN (e.g. 02, 04).
2. "**" is the lot sequence.
3. "XXX" denotes the last three characters of the Asm lot (20-QFN only).
4. "YYWW", "YWW", "YW", or "Y" is the last digit(s) of the year and week that the part was assembled.
5. "\$" denotes the mark code.
6. "G" after the two-letter package code denotes RoHS compliant package.
7. "K" denotes extended temperature range device.
8. Bottom marking: LOT and COO (TSSOP only).

Thermal Characteristics

Package	Applies to	Θ_{JA}	Θ_{JC}	Θ_{JB}	Units
8-TSSOP	5PB1102, 5PB1104	122.0	58.2	139.3	°C/W; still air
14-TSSOP	5PB1106	84.5	44.2	64.5	°C/W; still air
16-TSSOP	5PB1108	80.9	43.3	60.1	°C/W; still air
20-TSSOP	5PB1110	72.5	37.9	49.8	°C/W; still air
8-DFN	5PB1102, 5PB1104	120.2	99.4	63.3	°C/W; still air
16-QFN	5PB1106, 5PB1108	115.6	83.1	61.8	°C/W; still air
20-QFN	5PB1110	49.6	94.7	5.1	°C/W; still air

Package Outline Drawings (8-DFN, 2 x 2 mm Body, 0.5mm pitch)

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	09/18/14	J.HUA



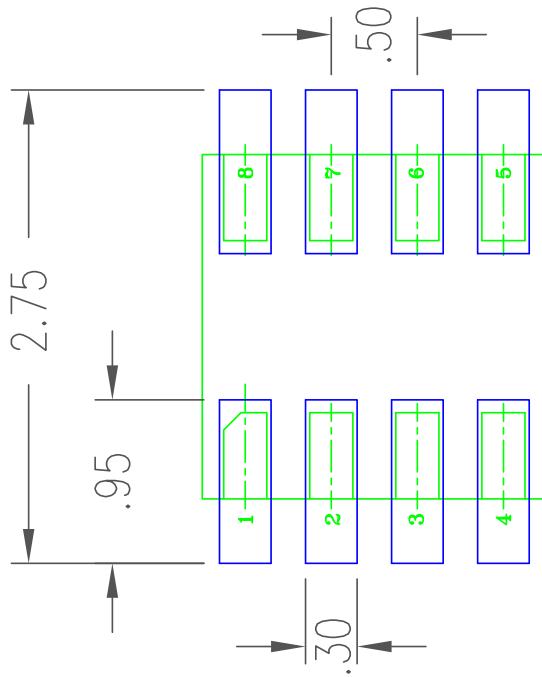
NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
2. ALL DIMENSIONS ARE IN MILLIMETERS

TOLERANCES UNLESS SPECIFIED DECIMAL ± XXX ± XXXX ±	APPROVALS DRAWN <i>[Signature]</i> CHECKED <i>[Signature]</i>	DATE 08/10/14 09/10/14	TITLE CMGB PACKAGE OUTLINE 2.0 X 2.0 mm BODY 0.5mm PITCH VQFN
TOLERANCES UNLESS SPECIFIED ANGULAR ± XXX ± XXXX ±	APPROVALS DRAWN <i>[Signature]</i> CHECKED <i>[Signature]</i>	DATE 08/10/14 09/10/14	TITLE CMGB PACKAGE OUTLINE 2.0 X 2.0 mm BODY 0.5mm PITCH VQFN
IDT www.idt.com 6024 SILVER CREEK VALLEY ROAD San Jose, CA 95138 PHONE: (408) 284-8200 FAX: (408) 492-8674	SIZE C	DRAWING No. PSC-4490	REV 00
DO NOT SCALE DRAWING			SHEET 1 OF 2

Package Outline Drawings, cont. (8-DFN, 2 x 2 mm Body, 0.5mm pitch)

REVISIONS		
REV	DESCRIPTION	DATE
00	INITIAL RELEASE	09/18/14



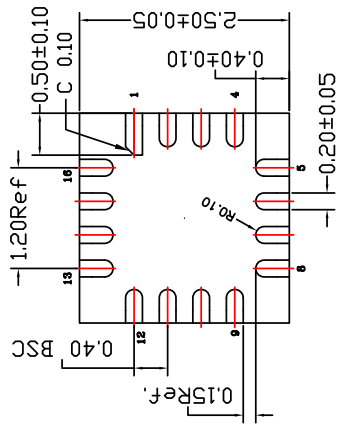
RECOMMENDED LAND PATTERN DIMENSION

- NOTES:
1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
 2. TOP DOWN VIEW. AS VIEWED.
 3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
 4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
 5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR MOUNT DESIGN AND LAND PATTERN.

TOLERANCES UNLESS SPECIFIED	DECIMAL	ANGULAR	±
XXXX±			
APPROVALS	DATE	TITLE	CMG8 PACKAGE OUTLINE
DRAWN	04/09/10/14	SIZE	2.0 X 2.0 mm BODY
CHECKED			0.5 mm PITCH VFOFN
		DRAWING No.	PSC-4490
		REV	00
		DO NOT SCALE DRAWING	SHEET 2 OF 2

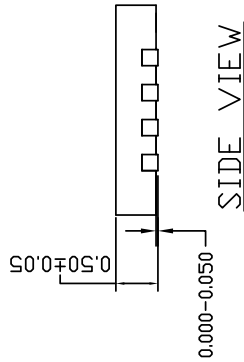
Package Outline Drawings (16-VFQFN, 2.5 x 2.5 mm Body, 0.4mm pitch)

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	04/03/14	JH
01	ADD PINTI CHAMFER	12/11/14	JH



TOP VIEW

BOTTOM VIEW



SIDE VIEW

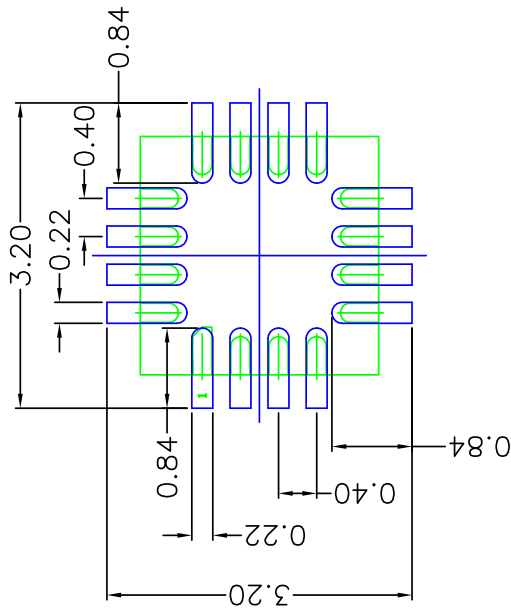
TOLERANCES UNLESS SPECIFIED DECIMAL XX± XXX±	INITIAL	DATE	6024 Silver Creek Valley Road San Jose CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-8591 www.IDT.com
	SPECIFIED	ANGULAR	
±1°			
APPROVALS	DATE	TITLE	
	04/03/14	CMG 16 PACKAGE OUTLINE	
DRAWN	J%	2.5 x 2.5 mm BODY	
CHECKED		0.40 mm PITCH VFQFN	
		SIZE	REV
		C	01
		DRAWING No. PSC-4478	
		DO NOT SCALE DRAWING	
		SHEET 1 OF 2	

NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1982
2. ALL DIMENSIONS ARE IN MILLIMETERS.

Package Outline Drawings, cont. (16-VFQFN, 2.5 x 2.5 mm Body, 0.4mm pitch)

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	04/03/14	JH
01	ADD PIN1 CHAMFER	12/11/14	JH



RECOMMENDED LAND PATTERN DIMENSION

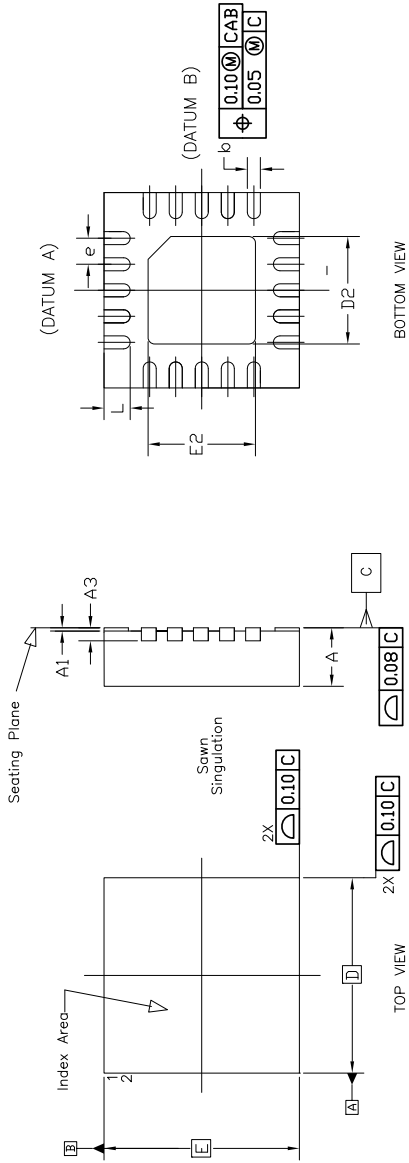
NOTES:

1. ALL DIMENSIONS ARE IN MM. ANGLES IN DEGREES.
2. TOP DOWN VIEW AS VIEWED ON PCB.
3. COMPONENT OUTLINE IS SHOWN FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

TOLERANCES UNLESS SPECIFIED DECIMAL XX± XXX±	ANGULAR ±1°	APPROVALS	DATE	IDT™ 6024 Silver Creek Valley Road San Jose CA 95138 PHONE: (408) 284-8200 WWW.IDT.COM FAX: (408) 284-8591
			04/03/14	
				TITLE
				CMG 16 PACKAGE OUTLINE
				2.5 x 2.5 mm BODY
				0.40 mm PITCH VFQFN
				SIZE
				C
				DRAWING No.
				PSC-4478
				REV
				01
				DO NOT SCALE DRAWING
				SHEET 2 OF 2

Package Outline Drawings (20-QFN, 3 x 3 mm Body, 0.4mm pitch)

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	3/30/16	JH



Symbol	DIMENSION		
	Min	Norm	Max
A	0.80	0.90	1.00
A1	0	0.02	0.05
A3	0.20 Ref		
b	0.17	0.20	0.25
e	0.40 BASIC		
N	20		
ND	5		
NE	5		
D	3.00 BASIC		
E	3.00 BASIC		
D2	1.55	1.65	1.75
E2	1.55	1.65	1.75
L	0.30	0.40	0.50

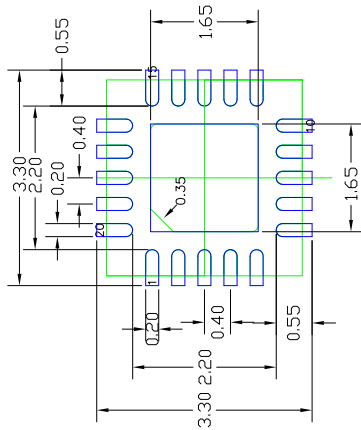
- NOTE :
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
 2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
 3. COPLANARITY SHALL NOT EXCEED 0.05 mm.
 4. PACKAGE LENGTH / PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC. (S)
 5. REFER JEDEC MO-220.

TOLERANCES UNLESS SPECIFIED	DATE	APPROVALS	TITLE
DECIMAL ±1°	3/30/16		ND/NDG 20 PACKAGE OUTLINE
XX±			3.0 x 3.0 mm BODY, EPAD 1.65 mm SQ
XXX±			0.40 PITCH QFN
DRAWN <i>QAG</i>	CHECKED		
SIZE		DRAWING No.	REV
C		PSC-4179-02	00
DO NOT SCALE DRAWING			SHEET 1 OF 2

6024 Silver Creek Valley Road
San Jose CA 95138
PHONE: (408) 284-8200
FAX: (408) 284-8591
WWW.IDT.COM

Package Outline Drawings, cont. (20-QFN, 3 x 3 mm Body, 0.4mm pitch)

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	3/30/16	JH



RECOMMENDED LAND PATTERN DIMENSION

NOTES:

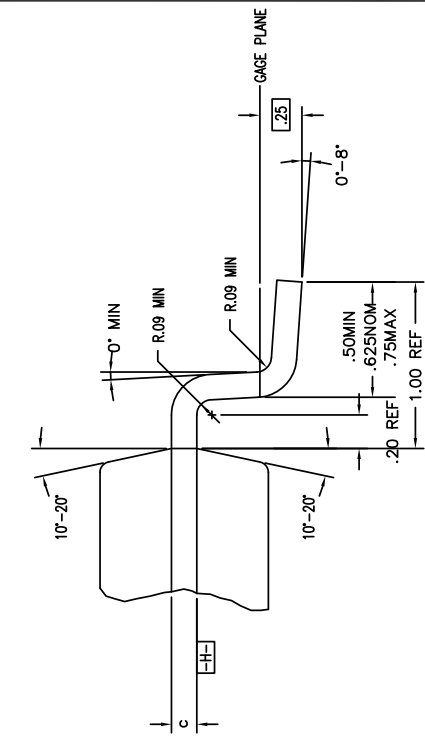
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
2. TOP-DOWN VIEW, AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOWS FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

6024 Silver Creek Valley Road San Jose CA 95138 PHONE: (408) 284-8200 FAX: (408) 284-8591 WWW.IDT.COM		TITLE ND/NDG 20 PACKAGE OUTLINE 3.0 x 3.0 mm BODY, EPAD 1.65 mm SQ 0.40 PITCH QFN	
TOLERANCES UNLESS SPECIFIED	DATE	SIZE	REV
DECIMAL ±1°	3/30/16	C	00
XX±		DRAWING No. PSC-4179-02	
XXX±		DO NOT SCALE DRAWING	
APPROVALS	CHECKED	SHEET 2 OF 2	

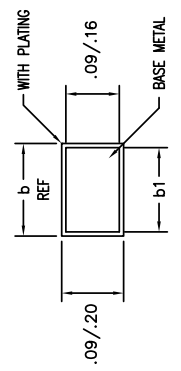
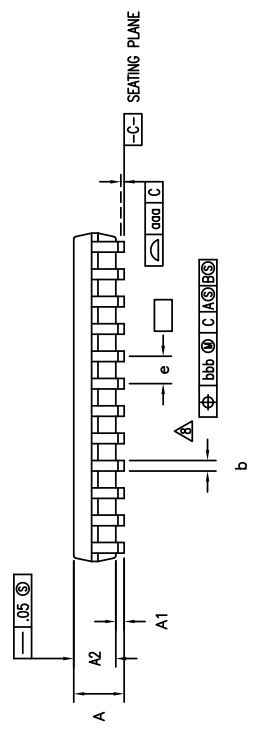
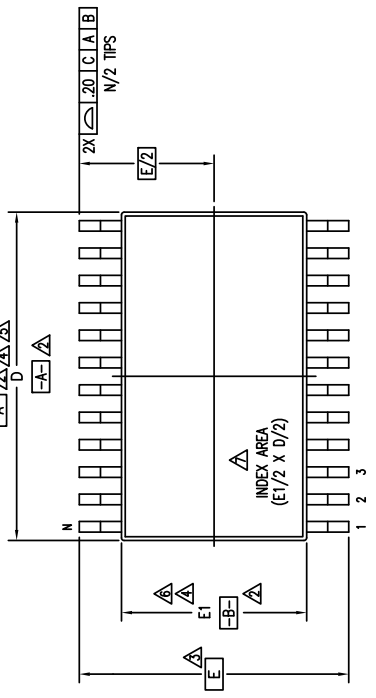
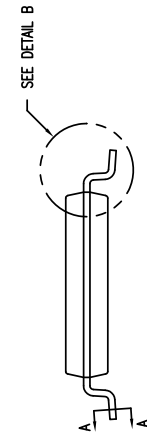
Package Outline Drawings (8-, 14-, 16-, 20-TSSOP)

DATE		REVISIONS	
CREATED	REV	DESCRIPTION	AUTHOR
08/25/98	02	ADD 14 & 16 LD	T. VU
07/10/99	03	ADD 8 LD	T. VU
5/23/01	04	ADDED TOPMARK TO TITLE	
10/14/04	05	ADD "GREEN" PGG NOMENCLATURE	TU VU
3/8/13	06	ADDED PACKAGE CODE	RAC
9/3/14	07	ADD TOLERANCE FOR A, A1, E AND b	CK LEE
3/10/17	08	ADD OPTION T1	R.TANH

NOTE: REFER TO DCP FOR OFFICIAL RELEASE DATE



DETAIL B



SECTION A-A

TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR ± XXX. XXXX. XXXXX.	IDT™ 2975 Stender Way Santa Clara, CA 95054 PHONE: (408) 727-8116 WWW.IDT.COM FAX: (408) 492-8874	TITLE	PC/PGG PACKAGE OUTLINE (PG OR PA TOPMARK CODE)
		SIZE	4.4 mm BODY WIDTH TSSOP .65 mm PITCH
		DRAWING No.	PSC-4056
		REV	08
		DO NOT SCALE DRAWING SHEET 1 OF 3	

Package Outline Drawings, cont. (8-, 14-, 16-, 20-TSSOP)

DATE CREATED		REV		DESCRIPTION		AUTHOR	
08/25/98		02		ADD 14 & 16 LD		T. VU	
07/10/99		03		ADD 8 LD		T. VU	
5/23/01		04		ADDED TOPMARK TO TITLE			
10/14/04		05		ADD "GREEN" PGC NOMENCLATURE		TU VU	
3/8/13		06		ADDED PACKAGE CODE		RAC	
9/3/14		07		ADD TOLERANCE FOR A, A1, E AND b		CK LEE	
3/10/17		08		ADD OPTION T1		R.TANH	

PG/PGC8		PG/PGC14		PG/PGC16		PG/PGC20		PG/PGC24		PG/PGC28		
SYMBOL	JEDEC VARIATION			NOM	JEDEC VARIATION			NOM	JEDEC VARIATION			
	MIN	NOM	MAX		MIN	NOM	MAX		MIN	NOM	MAX	
A	.85	1.10	1.20	.85	1.10	1.20	.85	1.10	1.20	.85	1.10	1.20
A1	.05	.10	.15	.05	.10	.15	.05	.10	.15	.05	.10	.15
A2	.80	1.00	1.05	.80	1.00	1.05	.80	1.00	1.05	.80	1.00	1.05
D	2.90	3.00	3.10	4.5	4.90	5.00	5.10	4.5	4.90	5.00	5.10	4.5
E	6.20	6.40	6.60	3	6.20	6.40	6.60	3	6.20	6.40	6.60	3
E1	4.30	4.40	4.50	4.6	4.30	4.40	4.50	4.6	4.30	4.40	4.50	4.6
e	.65 BSC			.65 BSC	.65 BSC			.65 BSC	.65 BSC			.65 BSC
b	.19	.25	.30	.19	.25	.30	.19	.25	.30	.19	.25	.30
b1	.19	.22	.25	.19	.22	.25	.19	.22	.25	.19	.22	.25
aaa	-	-	.10	-	-	.10	-	-	.10	-	-	.10
bbb	-	-	.10	-	-	.10	-	-	.10	-	-	.10
N	8			14	16			20	24			28

NOTE: REFER TO DCP FOR OFFICIAL RELEASE DATE

OPTION T1	
SYMBOL	PGG14T1
	JEDEC VARIATION
A	.90
A1	.05
A2	.80
D	4.90
E	6.20
E1	4.30
e	.65 BSC
b	.19
b1	.19
c	.09
aaa	-
bbb	-
N	14

NOTES:

- ALL DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M-1994
- DATUMS **-A-** AND **-B-** TO BE DETERMINED AT DATUM PLANE **-H-**
- DIMENSION E TO BE DETERMINED AT SEATING PLANE **-C-**
- DIMENSIONS D AND E1 ARE TO BE DETERMINED AT DATUM PLANE **-H-**
- DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED .15 mm PER SIDE
- DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS. INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED .25 mm PER SIDE
- DETAIL OF PIN 1 IDENTIFIER IS OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED
- LEAD WIDTH DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION IS .08 mm IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .10 AND .25 mm FROM THE LEAD TIP
- ALL DIMENSIONS ARE IN MILLIMETERS
- THIS OUTLINE CONFORMS TO JEDEC PUBLICATION 95 REGISTRATION MO-153, VARIATION AA, AB-1, AB, AC, AD & AE

TOLERANCES UNLESS SPECIFIED	
DECIMAL	±
XXX	±
XXXX	±
XXXXX	±

TITLE	
PG/PGC PACKAGE OUTLINE	PG OR PA TOPMARK CODE
4.4 mm BODY WIDTH TSSOP .65 mm PITCH	
SIZE	DRAWING No.
C	PSC-4056
REV	
O8	
DO NOT SCALE DRAWING	
SHEET 2 OF 3	

REVISIONS	
REV	DESCRIPTION
02	ADD 14 & 16 LD
03	ADD 8 LD
04	ADDED TOPMARK TO TITLE
05	ADD "GREEN" PGC NOMENCLATURE
06	ADDED PACKAGE CODE
07	ADD TOLERANCE FOR A, A1, E AND b
08	ADD OPTION T1

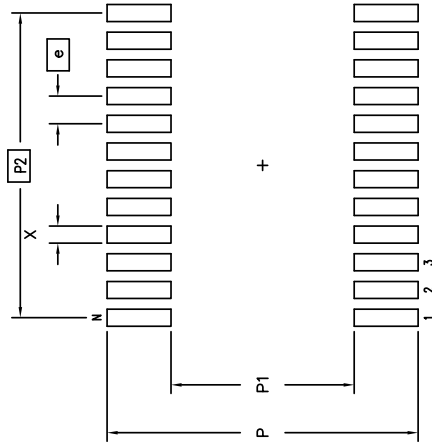
DATE CREATED		REV		DESCRIPTION		AUTHOR	
08/25/98		02		ADD 14 & 16 LD		T. VU	
07/10/99		03		ADD 8 LD		T. VU	
5/23/01		04		ADDED TOPMARK TO TITLE			
10/14/04		05		ADD "GREEN" PGC NOMENCLATURE		TU VU	
3/8/13		06		ADDED PACKAGE CODE		RAC	
9/3/14		07		ADD TOLERANCE FOR A, A1, E AND b		CK LEE	
3/10/17		08		ADD OPTION T1		R.TANH	

Package Outline Drawings, cont. (8-, 14-, 16-, 20-TSSOP)

DATE CREATED	REV	DESCRIPTION	AUTHOR
08/25/98	02	ADD 14 & 16 LD	T. VU
07/10/99	03	ADD 8 LD	T. VU
5/23/01	04	ADDED TOPMARK TO TITLE	
10/14/04	05	ADD "GREEN" PGG NOMENCLATURE	TU VU
3/8/13	06	ADDED PACKAGE CODE	RAC
9/3/14	07	ADD TOLERANCE FOR A, A1, E AND b	CK LEE
3/10/17	08	ADD OPTION T1	R.TANH

NOTE: REFER TO DCP FOR OFFICIAL RELEASE DATE

LAND PATTERN DIMENSIONS



	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
P	7.20	7.40	7.20	7.40	7.20	7.40	7.20	7.40	7.20	7.40	7.20	7.40
P1	4.20	4.40	4.20	4.40	4.20	4.40	4.20	4.40	4.20	4.40	4.20	4.40
P2	1.95 BSC		3.90 BSC		4.55 BSC		5.85 BSC		7.15 BSC		8.45 BSC	
X	.30	.50	.30	.50	.30	.50	.30	.50	.30	.50	.30	.50
e	.65 BSC		.65 BSC		.65 BSC		.65 BSC		.65 BSC		.65 BSC	
N	8		14		16		20		24		28	

TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR ± XXX± XXXX±

2975 Stander Way
Santa Clara, CA 95054
PHONE: (408) 727-6116
FAX: (408) 492-8674
WWW.IDT.COM

TITLE PGG/PGG PACKAGE OUTLINE
(PG OR PA TOPMARK CODE)
4.4 mm BODY WIDTH TSSOP .65 mm PITCH

SIZE C DRAWING No. PSC-4056 REV 08

DO NOT SCALE DRAWING SHEET 3 OF 3

Ordering Information (industrial temperature range)

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
5PB1102PGGI	see page 8	Tubes	8-TSSOP	-40 to +85°C
5PB1102PGGI8		Tape and Reel	8-TSSOP	-40 to +85°C
5PB1104PGGI		Tubes	8-TSSOP	-40 to +85°C
5PB1104PGGI8		Tape and Reel	8-TSSOP	-40 to +85°C
5PB1106PGGI		Tubes	14-TSSOP	-40 to +85°C
5PB1106PGGI8		Tape and Reel	14-TSSOP	-40 to +85°C
5PB1108PGGI		Tubes	16-TSSOP	-40 to +85°C
5PB1108PGGI8		Tape and Reel	16-TSSOP	-40 to +85°C
5PB1110PGGI		Tubes	20-TSSOP	-40 to +85°C
5PB1110PGGI8		Tape and Reel	20-TSSOP	-40 to +85°C
5PB1102CMGI		Cut Tape	8-DFN	-40 to +85°C
5PB1102CMGI8		Tape and Reel	8-DFN	-40 to +85°C
5PB1104CMGI		Cut Tape	8-DFN	-40 to +85°C
5PB1104CMGI8		Tape and Reel	8-DFN	-40 to +85°C
5PB1104CMGI/W*		Tape and Reel	8-DFN	-40 to +85°C
5PB1106CMGI		Cut Tape	16-QFN	-40 to +85°C
5PB1106CMGI8		Tape and Reel	16-QFN	-40 to +85°C
5PB1108CMGI		Cut Tape	16-QFN	-40 to +85°C
5PB1108CMGI8		Tape and Reel	16-QFN	-40 to +85°C
5PB1110NDGI		Tubes	20-QFN	-40 to +85°C
5PB1110NDGI8	Tape and Reel	20-QFN	-40 to +85°C	

* "/W" stands for tape and reel with pin 1 orientation: EIA-481-D. All other tape and reels options come with EIA-481-C pin 1 orientation.

Ordering Information (extended temperature range)

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
5PB1102PGGK	see page 9	Tubes	8-TSSOP	-40 to +105°C
5PB1102PGGK8		Tape and Reel	8-TSSOP	-40 to +105°C
5PB1104PGGK		Tubes	8-TSSOP	-40 to +105°C
5PB1104PGGK8		Tape and Reel	8-TSSOP	-40 to +105°C
5PB1106PGGK		Tubes	14-TSSOP	-40 to +105°C
5PB1106PGGK8		Tape and Reel	14-TSSOP	-40 to +105°C
5PB1108PGGK		Tubes	16-TSSOP	-40 to +105°C
5PB1108PGGK8		Tape and Reel	16-TSSOP	-40 to +105°C
5PB1110PGGK		Tubes	20-TSSOP	-40 to +105°C
5PB1110PGGK8		Tape and Reel	20-TSSOP	-40 to +105°C
5PB1102CMGK		Cut Tape	8-DFN	-40 to +105°C
5PB1102CMGK8		Tape and Reel	8-DFN	-40 to +105°C
5PB1104CMGK		Cut Tape	8-DFN	-40 to +105°C
5PB1104CMGK8		Tape and Reel	8-DFN	-40 to +105°C
5PB1106CMGK		Cut Tape	16-QFN	-40 to +105°C
5PB1106CMGK8		Tape and Reel	16-QFN	-40 to +105°C
5PB1108CMGK		Cut Tape	16-QFN	-40 to +105°C
5PB1108CMGK8		Tape and Reel	16-QFN	-40 to +105°C
5PB1110NDGK		Tubes	20-QFN	-40 to +105°C
5PB1110NDGK8		Tape and Reel	20-QFN	-40 to +105°C

“G” after the two-letter package code denotes Pb-Free configuration, RoHS compliant.

Revision History

Date	Description of Change
March 20, 2015	Initial release.
May 19, 2015	1. Expanded Output Enable function text in General Description, and within the note under "Output Logic Table". 2. Updated all "Buffer Additive Phase Jitter, RMS" conditions from 125MHz to 156.25MHz.
June 9, 2015	1. Corrected typos in part numbers in DC Electrical Tables. 2. Updated existing Output Rise/Fall Time specs for 5pF load. 3. Added additional Output Rise/Fall specs for 2pF load.
June 15, 2015	Fixed typos in Output Rise/Fall Time 5pF specs for CL conditions; should be 5pF; not 2pF.
June 22, 2015	Changed 3.3V Operating Voltage spec from 3.15V min to 3.135V min; 3.45V max to 3.465V max.
August 24, 2015	1. Added 5PB1104CMGIW orderable part. 2. Updated Abs Max Ratings table for "Output Enable and All outputs" and "CLKIN"; changed -0.5 V to -0.4 and added -0.4 to... respectively.
May 13, 2016	Replace NDG20 package outline drawing with latest version.
December 15, 2016	Updated marking diagrams for all TSSOP devices.
February 10, 2017	Change Propagation Delay maximum spec in 1.8V AC electrical characterization table from 2.2 to 2.5ns.
March 28, 2017	1. Updated Propagation Delay specifications for 5PB1106/08/10; 2.5V and 3.3V. 2. Updated output-output skew maximum specifications for 5PB1106; 1.8V, 2.5V, 3.3V. 3. Updated legal disclaimer. 4. Updated package outline drawings.
May 17, 2017	Added thermal theta JA, JB, JC values to all parts.
May 23, 2017	1. Updated 3.3V, 2.5V, and 1.8V IDD typical and maximum values. 2. Updated ordering information.
September 19, 2017	Updated Input High Voltage, CLKIN (VIH) maximum values.
February 20, 2018	Updated absolute maximum supply voltage from 3.465V to 3.8V.



Corporate Headquarters
6024 Silver Creek Valley Road
San Jose, CA 95138 USA
www.idt.com

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1-800-345-7015 or 408-284-8200
Fax: 408-284-2775
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Tech Support
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